

Global Change Notification (GCN)

Product Family	Chipsim	10728908
		GCN Number
Series	91228	November 10, 2015
		Date Issued
Reason For Change	Change In Packaging Specifications	
Change Description	This is to inform you that Molex are making a change to the packaging of the Chipsim 91228 product. There will be a change to the size of the box but no change to the MOQ. The reason for this change is to strengthen packaging during shipping at the request of the customer.	
Part Numbers Affected	Please refer to CustomerPartList.csv attached to e-mail message.	
Reason For Short Notice Exception	8D Corrective Action Changes	
Assessment Of Change (How Product Will Be Qualified & Validated)	This change will have no effect on fit, form or function of the product.	
Internal Molex Qualification Date (Planned Date Information Available)	November 06, 2015	
Sample Availability Date (Changed Part)	November 13, 2015	
Date of Implementation	November 23, 2015	
Method of Identifying Change	Factory order number	
Recommended Replacement Parts	N/A	
Last Time Buy Date for Obsolete Parts		
Last Time Ship Date for Obsolete Parts		

Contact	Name	E-mail	Phone Number
Sales Engineer	Please refer to e-mail message for your local sales engineer.		
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